TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

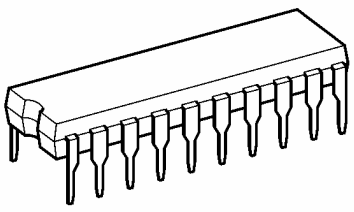
TC74HC7240AP,TC74HC7240AF,TC74HC7244AP,TC74HC7244AF

Octal Bus Buffer (with schmitt trigger inputs)

TC74HC7240AP/AF Inverted, 3-State Outputs

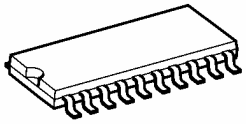
TC74HC7244AP/AF Non-Inverted, 3-State Outputs

TC74HC7240AP, TC74HC7244AP



DIP20-P-300-2.54A

TC74HC7240AF, TC74HC7244AF



SOP20-P-300-1.27A

Weight

DIP20-P-300-2.54A : 1.30 g (typ.)

SOP20-P-300-1.27A : 0.22 g (typ.)

The TC74HC7240A/7244A are high speed CMOS OCTAL BUS BUFFERs with silicon gate C^2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The TC74HC7240A/7244A have same pin configuration and function as the TC74HC240A/244A. And they have a hystereis characterictics with each input, so TC74HC7240A/7244A can be used as a line receiver, etc.

They have two active low output enables.

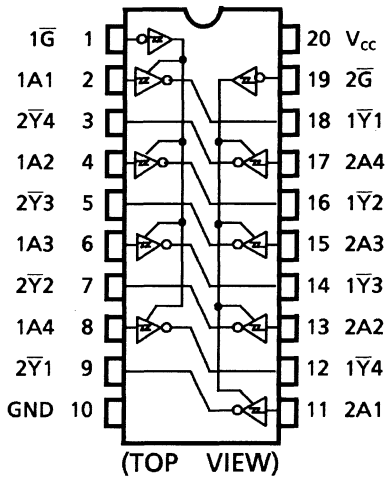
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

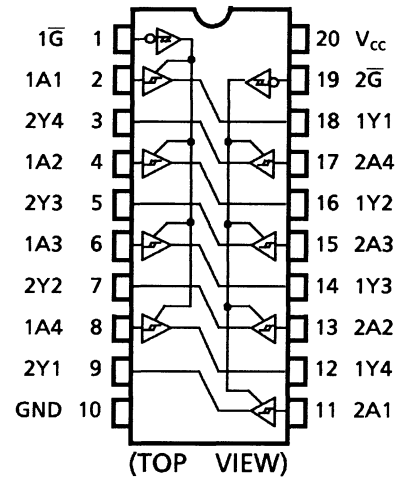
- High speed: t_{pd} = 15 ns (typ.) at V_{CC} = 5 V
- Low power dissipation: I_{CC} = 4 μA (max) at Ta = 25°C
- High noise immunity: V_H = 1.1 V (typ.) at V_{CC} = 5 V
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL}$ = 6 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 6 V
- Pin and function compatible with 74LS240/244

Pin Assignment

TC74HC7240A

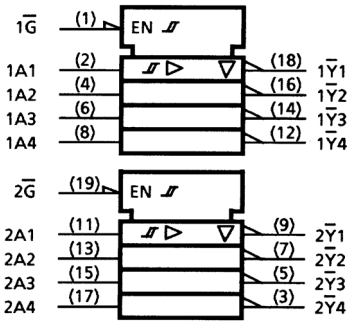


TC74HC7244A

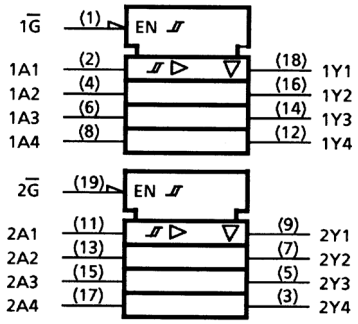


IEC Logic Symbol

TC74HC7240A



TC74HC7244A



Truth Table

Inputs		Outputs	
$\overline{G}$	A_n	Y_n	$\overline{Y}_n$ Δ
L	L	L	H
L	H	H	L
H	X	Z	Z

Δ: For TC74HC7240A only

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7	V
DC input voltage	V_{IN}	−0.5 to V_{CC} + 0.5	V
DC output voltage	V_{OUT}	−0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}	±20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±35	mA
DC V_{CC}/ground current	I_{CC}	±75	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = −40 to 65°C. From Ta = 65 to 85°C a derating factor of −10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	−40 to 85	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max	
Positive threshold voltage	V_P	—	2.0	1.0	1.25	1.5	1.0	1.5	V
			4.5	2.3	2.7	3.15	2.3	3.15	
			6.0	3.0	3.5	4.2	3.0	4.2	
Negative threshold voltage	V_N	—	2.0	0.3	0.65	0.9	0.3	0.9	V
			4.5	1.13	1.6	2.0	1.13	2.0	
			6.0	1.5	2.3	2.6	1.5	2.6	
Hysteresis voltage	V_H	—	2.0	0.3	0.6	1.0	0.3	1.0	V
			4.5	0.6	1.1	1.4	0.6	1.4	
			6.0	0.8	1.2	1.7	0.8	1.7	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	2.0	1.9	2.0	—	1.9	—	V
		I_{OH} = −20 μA	4.5	4.4	4.5	—	4.4	—	
			6.0	5.9	6.0	—	5.9	—	
		I_{OH} = −6 mA	4.5	4.18	4.31	—	4.13	—	
		I_{OH} = −7.8 mA	6.0	5.68	5.80	—	5.63	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	2.0	—	0.0	0.1	—	0.1	V
		I_{OL} = 20 μA	4.5	—	0.0	0.1	—	0.1	
			6.0	—	0.0	0.1	—	0.1	
		I_{OL} = 6 mA	4.5	—	0.17	0.26	—	0.33	
		I_{OL} = 7.8 mA	6.0	—	0.18	0.26	—	0.33	
3-state output off-state current	I_{OZ}	V_{IN} = V_{IH} or V_{IL} V_{OUT} = V_{CC} or GND	6.0	—	—	±0.5	—	±5.0	μA
Input leakage current	I_{IN}	V_{IN} = V_{CC} or GND	6.0	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND	6.0	—	—	4.0	—	40.0	μA

AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
			CL (pF)	V_{CC} (V)	Min	Typ.	Max	Min	Max	
Output transition time	t_{TLH} t_{THL}	—	50	2.0	—	25	60	—	75	ns
				4.5	—	7	12	—	15	
				6.0	—	6	10	—	13	
Propagation delay time	t_{pLH} t_{pHL}	—	50	2.0	—	50	125	—	155	ns
				4.5	—	15	25	—	31	
				6.0	—	13	21	—	26	
			150	2.0	—	67	165	—	205	
				4.5	—	20	33	—	41	
				6.0	—	17	28	—	35	
Output enable time	t_{pZL} t_{pZH}	R_L = 1 kΩ	50	2.0	—	68	150	—	190	ns
				4.5	—	21	30	—	38	
				6.0	—	16	26	—	32	
			150	2.0	—	84	165	—	230	
				4.5	—	26	37	—	46	
				6.0	—	20	31	—	39	
Output disable time	t_{pLZ} t_{pHZ}	R_L = 1 kΩ	50	2.0	—	48	150	—	190	ns
				4.5	—	21	30	—	38	
				6.0	—	19	26	—	32	
Input capacitance	C_{IN}	—			—	5	10	—	10	pF
Output capacitance	C_{OUT}	—			—	10	—	—	—	pF
Power dissipation capacitance	C_{PD} (Note)	TC74HC7240A			—	33	—	—	—	pF
		TC74HC7244A			—	34	—	—	—	

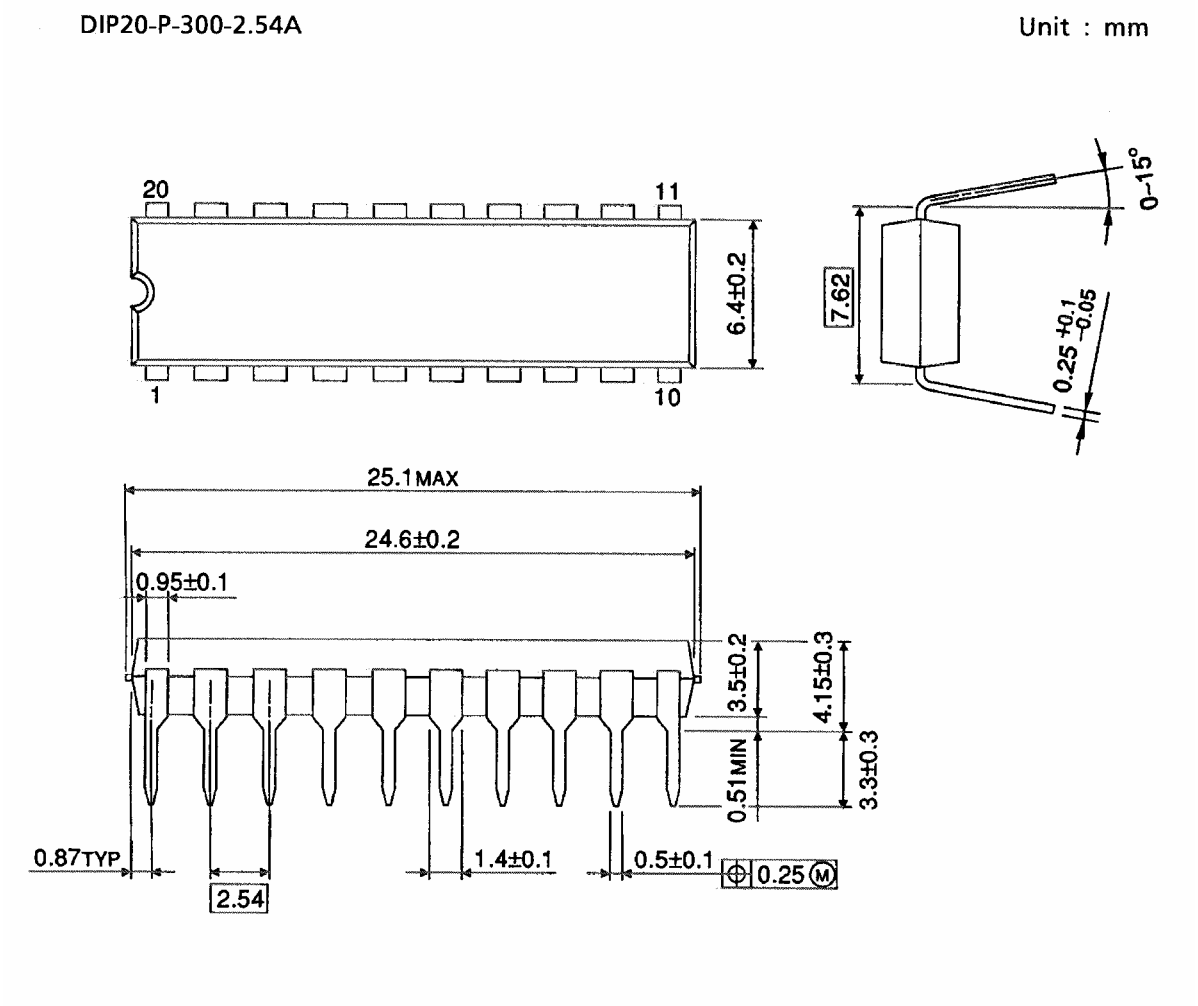
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}\ (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8\ (per\ bit)$$

Package Dimensions

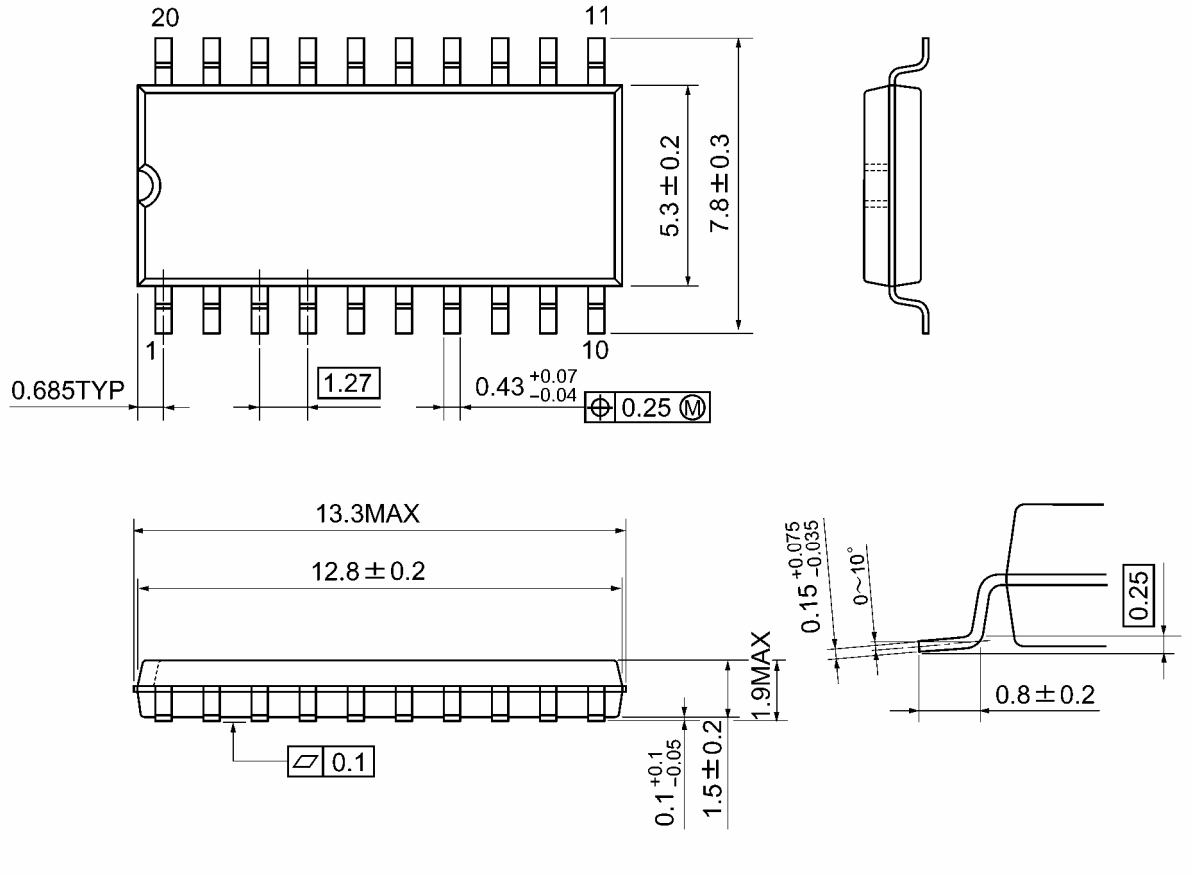
DIP20-P-300-2.54A Unit : mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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20070701-EN GENERAL

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